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In the claims:

- 1. (Currently Amended) An integrated electronic system housing and magnet structure for an imaging system comprising:
 - a magnet structure comprising containing;

a superconducting magnet; and

an RF coil assembly;

a housing attached to and external from said magnet structure, said housing containing imaging system support electronics <u>having a controller</u> and not said RF coil assembly; and

a radio frequency shield coupled to said housing and preventing radio frequency interference between said imaging system support electronics and said RF coil assembly.

- 2. (Previously Presented) An integrated electronic system housing and magnet structure as in claim 1 wherein said radio frequency shield is coupled within said housing.
- 3. (Previously Presented) An integrated electronic system housing and magnet structure as in claim 1 wherein said imaging system support electronics is encased in said radio frequency shield.
- 4. (Previously Presented) An integrated electronic system housing and magnet structure as in claim 1 wherein said radio frequency shield is coupled within said housing and encases said imaging system support electronics.
- 5. (Previously Presented) An integrated electronic system housing and magnet structure as in claim 1 wherein said imaging system support electronics comprises at least one of a radio frequency amplifier, a gradient

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amplifier, a timing device, an oscillator, a radio frequency transmitter, a gradient coil controller, and a sequence controller.

- 6. (Previously Presented) An integrated electronic system housing and magnet structure as in claim 1 wherein said radio frequency shield comprises at least one layer.
- 7. (Previously Presented) An integrated electronic system housing and magnet structure as in claim 6 wherein said at least one layer comprises:

a first layer; and

a second layer coupled to said first layer;

said first layer and said second layer having capacitance therebetween.

- 8. (Previously Presented) An integrated electronic system housing and magnet structure as in claim 1 wherein said radio frequency shield is metallic.
- 9. (Previously Presented) An integrated electronic system housing and magnet structure as in claim 1 wherein said radio frequency shield is a conductive mesh.
- 10. (Previously Presented) An integrated electronic system housing and magnet structure as in claim 1 wherein said radio frequency shield is a superconductor.
- 11. (Previously Presented) An integrated electronic system housing and magnet structure as in claim 1 wherein said radio frequency shield comprises at least one void.

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- (Previously Presented) An integrated electronic system housing 12. and magnet structure as in claim 1 wherein said radio frequency shield reflects radio frequencies.
 - An imaging system comprising: (Currently Amended) 13.
- a magnet structure generating at least one magnetic field and comprising containing;

a superconducting magnet;

a gradient coil assembly; and

an RF coil assembly;

a first housing external, separate, and coupled to said magnet structure and havingcontaining imaging system support electronics having a microprocessor and not said RF coil assembly; and

a radio frequency shield coupled to said housing and preventing radio frequency interference between said at least one magnetic field and said imaging system support electronics.

- 14. (Previously Presented) An imaging system as in claim 13 further comprising a second housing containing said magnet structure, wherein said first housing and said second housing are integrally formed as a single unit.
- A system as in claim 13 wherein said imaging system 15. (Original) support electronics is encased in said radio frequency shield.
- A system as in claim 13 wherein said radio frequency 16. (Original) shield is coupled within said housing and encases said imaging system support electronics.
- 17. (Original) A system as in claim 13 wherein said radio frequency shield comprises at least one layer.

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- 18. (Original) A system as in claim 17 wherein said at least one layer comprises:
 - a first layer; and
 - a second layer coupled to said first layer;
 - said first layer and said second layer having capacitance therebetween.
- 19. (Original) A system as in claim 13 wherein said radio frequency shield is metallic.
- 20. (Original) A system as in claim 13 wherein said radio frequency shield is a conductive mesh.
- 21. (Original) A system as in claim 13 wherein said radio frequency shield is a superconductor.
 - 22. (Currently Amended) An imaging system comprising:
- a first housing having imaging system support electronics comprising at least one of a radio frequency amplifier, a gradient amplifier, a timing device, an oscillator, a radio frequency transmitter, a gradient coil controller, and a sequence controller;
- a second housing integrally formed with said first housing and containing a magnet structure that is separate from said first housing, generates at least one magnetic field, and comprises contains;
 - a superconducting magnet;
 - a gradient coil assembly; and
 - at least one radio frequency receiver coil; and
- a radio frequency shield coupled within said first housing, encasing said imaging system support electronics, and preventing radio frequency interference

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between said imaging system support electronics and said at least one radio frequency receiver coil.

- An integrated electronic system (Previously Presented) 23. housing and magnet structure as in claim 1 wherein said housing does not contain said magnet structure.
- An integrated electronic system 24. (Previously Presented) housing and magnet structure as in claim 1 wherein said magnet structure and said imaging system support electronics reside within the same room.
- A system as in claim 13 further 25. (Previously Presented) comprising a second housing that is separate, attached, and external from said first housing and contains said magnet structure.
- An integrated electronic system housing and magnet 26. (New) structure for an imaging system comprising:
 - a magnet structure comprising;
 - a superconducting magnet; and
 - an RF coil assembly;
- a housing attached to and external from said magnet structure, said housing containing imaging system support electronics and not said RF coil assembly; and
- a radio frequency shield coupled to said housing and preventing radio frequency interference between said imaging system support electronics and said RF coil assembly;

wherein said radio frequency shield comprises;

- a first layer; and
- a second layer coupled to said first layer;

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said first layer and said second layer having capacitance, but not capacitors therebetween.